

PHOTOCOUPLER PS2705A-1

HIGH ISOLATION VOLTAGE SOP PHOTOCOUPLER

-NEPOC Series-

DESCRIPTION

The PS2705A-1 is an optically coupled isolator containing a GaAs light emitting diode and an NPN silicon phototransistor to realize an excellent cost performance.

This package is SOP (Small Outline Package) type and has shield effect to cut off ambient light.

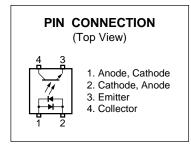
It is designed for high density mounting applications.

FEATURES

- AC input response
- High isolation voltage (BV = 3 750 Vr.m.s.)
- SOP (Small Outline Package) type
- Ordering number of taping product: PS2705A-1-F3, F4
- Pb-Free product
- · Safety standards
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

APPLICATIONS

- Hybrid IC
- Telephone/FAX.
- FA/OA equipment
- Programmable logic controllers
- Power supply

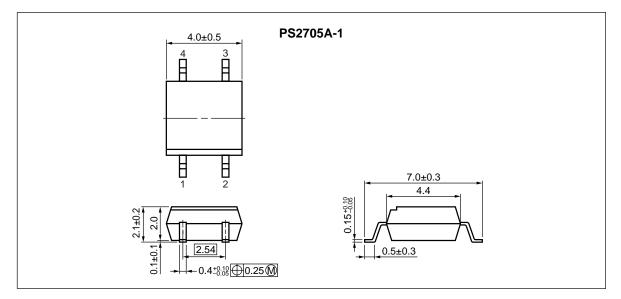


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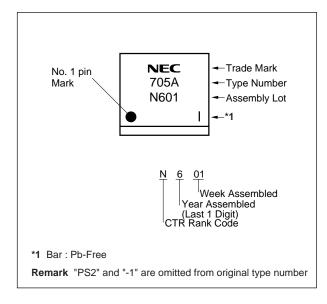
Document No. PN10397EJ03V0DS (3rd edition) Date Published March 2006 CP(K)

The mark **★** shows major revised points.

PACKAGE DIMENSIONS (in millimeters)



MARKING EXAMPLE



★ ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
PS2705A-1	PS2705A-1-A	Pb-Free	Magazine case 100 pcs	Standard products	PS2705A-1
PS2705A-1-F3	PS2705A-1-F3-A		Embossed Tape 3 500 pcs/reel	(UL approved)	
PS2705A-1-F4	PS2705A-1-F4-A				
PS2705A-1-V	PS2705A-1-V-A		Magazine case 100 pcs	DIN EN60747-5-2	
PS2705A-1-V-F3	PS2705A-1-V-F3-A		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)	
PS2705A-1-V-F4	PS2705A-1-V-F4-A			Approved (Option)	

*1 For the application of the Safety Standard, following part number should be used.

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	Parameter	Symbol	Ratings	Unit
Diode	Forward Current (DC)	lf	±30	mA
	Power Dissipation Derating	⊿P₀/°C	0.8	mW/°C
	Power Dissipation	PD	80	mW
	Peak Forward Current ^{*1}	IFP	±0.5	А
Transistor	Collector to Emitter Voltage	Vceo	70	V
	Emitter to Collector Voltage	Veco	5	V
	Collector Current	lc	30	mA
	Power Dissipation Derating	⊿Pc/°C	1.5	mW/°C
	Power Dissipation	Pc	150	mW
Isolation Vo	Isolation Voltage ^{*2}		3 750	Vr.m.s.
Operating A	Ambient Temperature T _A -55 to +100		°C	
Storage Temperature		Tstg	–55 to +150	°C

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

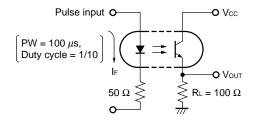
***1** PW = 100 μs, Duty Cycle = 1%

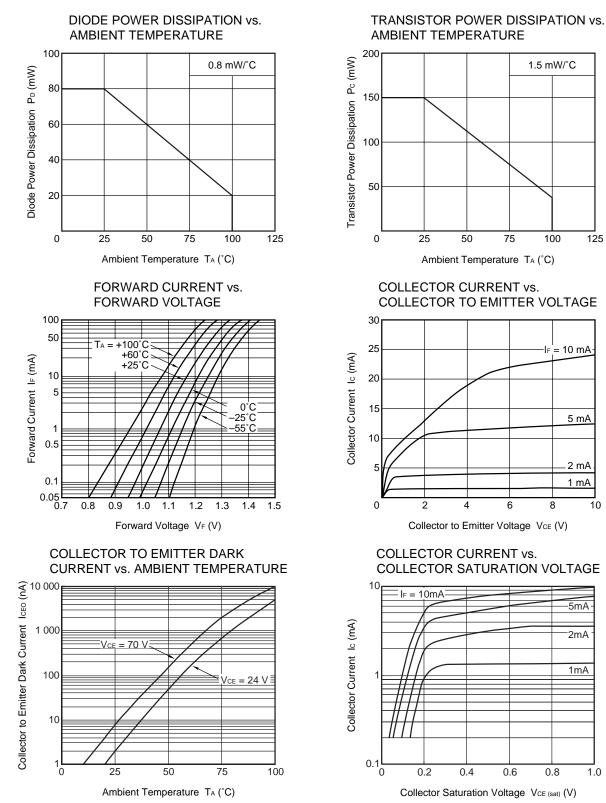
*2 AC voltage for 1 minute at $T_A = 25^{\circ}$ C, RH = 60% between input and output Pins 1-2 shorted together, 3-4 shorted together.

ELECTRICAL CHARACTERISTICS (T_A = 25°C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	$I_F = \pm 5 \text{ mA}$		1.2	1.4	V
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		20		pF
Transistor	Collector to Emitter Dark Current	ICEO	I⊧ = 0 mA, Vcε = 70 V			100	nA
Coupled	Current Transfer Ratio (Ic/IF) ^{*1}	CTR	$I_F = \pm 5$ mA, $V_{CE} = 5$ V	50		300	%
	Collector Saturation Voltage	Vce (sat)	I⊧ = ±10 mA, lc = 2 mA		0.13	0.3	V
	Isolation Resistance	Ri-o	VI-O = 1.0 kVDC	10 ¹¹			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1.0 MHz		0.4		pF
	Rise Time *2	tr	$V_{CC} = 5 \text{ V}, \text{ Ic} = 2 \text{ mA}, \text{ R}_{L} = 100 \Omega$		5		μS
	Fall Time *2	tr			7		

- *1 CTR rank
 - N: 50 to 300 (%)
 - L: 100 to 300 (%)
 - M: 50 to 150 (%)
- *2 Test circuit for switching time

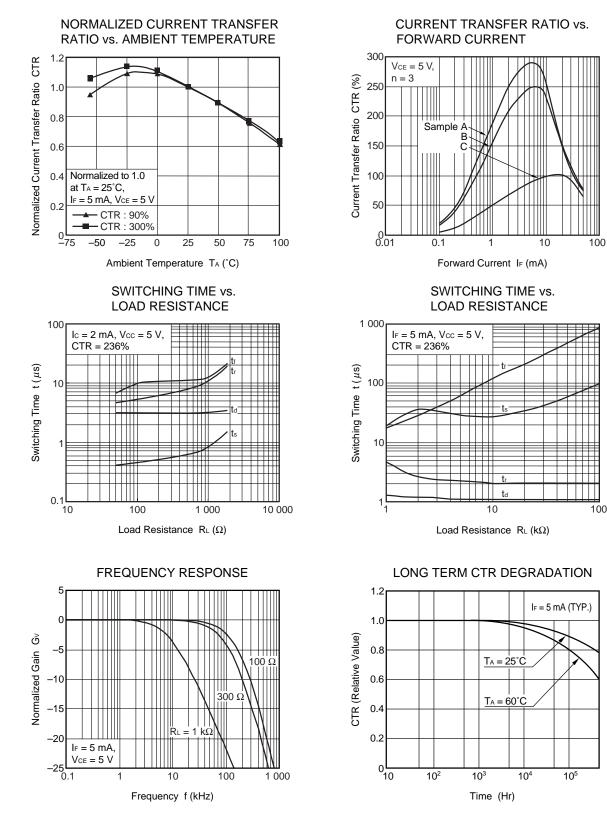




TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

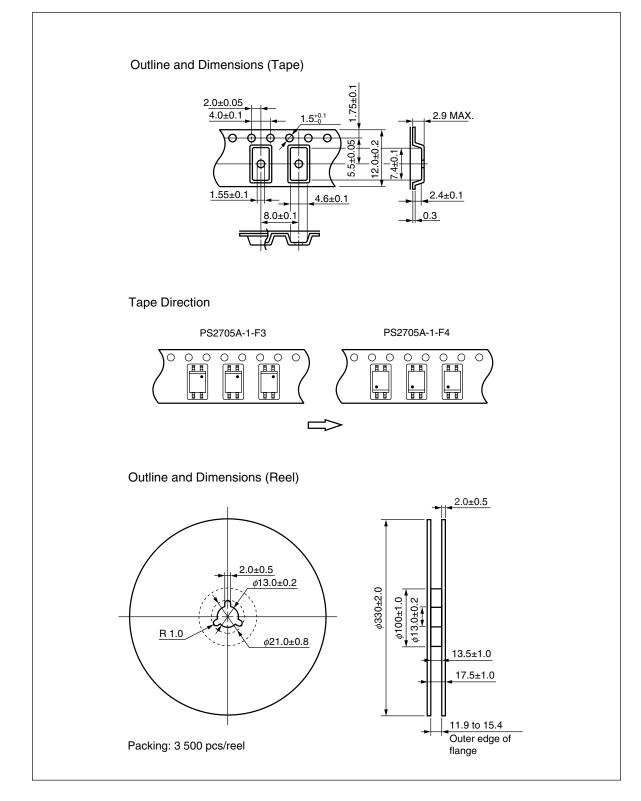
Remark The graphs indicate nominal characteristics.

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TAPING SPECIFICATIONS (in millimeters)



NOTES ON HANDLING

1. Recommended soldering conditions

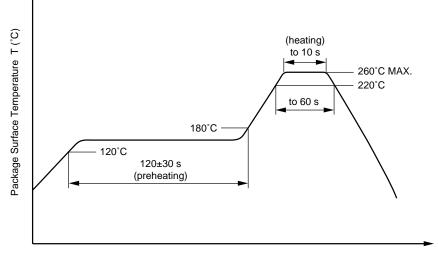
(1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

260°C or below (package surface temperature)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

Peak Temperature (lead part temperature)	350°C or below
Time (each pins)	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over 100°C

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

★ 3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. This tendency may sometimes be obvious, especially below $I_F = 1$ mA.

Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

USAGE CAUTIONS

1. Protect against static electricity when handling.

2. Avoid storage at a high temperature and high humidity.

When the product(s) listed in this document is subject to any applicable import or export control laws and regulation of the authority having competent jurisdiction, such product(s) shall not be imported or exported without obtaining the import or export license.

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M8E 00.4-0110

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	• Do not lick the product or in any way allow it to enter the mouth.

► For further information, please contact

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CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices	
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
PBB < 1000 PPM		Not Detected	
PBDE	< 1000 PPM	Not Detected	

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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